elmos



256 x 16 SPAD Array and 16-Channel Ultrashort Pulsed Laser Driver for Automotive LIDAR

Patents Pending

09.06.2020 Dr. André Srowig | The International SPAD Sensor Workshop 2020

Expert in analog mixed signal solutions focused on automotive market

elmos

35 years experience



- Development, production & marketing of ICs & pressure sensors
- Sales: ~85% automotive ~15% non-automotive
- Main strength: design of innovative products and specialized application know how

Worldwide leading products



- Elmos serves the megatrends (ADAS, EV...) & attractive niches with benchmark innovations
- #1 positions:
 - Ultrasonic Parking Assistance
 - Ambient LED Light
 - Climate Applications
 - Gesture Control
 - Soon Rear Light LED & more...

Ready for further growth



- Global player for automotive ASSPs and ASICs
- Significant addition to design/application resources
- Fablite: Flexible production strategy for Frontend and soon for Backend (Test)

From a statistical point of view: >4 Elmos ICs in every new car ...soon >5!

Optical Segment Target Applications

elmos







Proximity and Gesture

HALIOS® Technology

Control of Infotainment system Simple Gesture recognition Gestures in interior

USPs High light immunity Best cost/low latency

Gesture and Object Recognition

ToF Imager

3D object recognition Gestures in interior & exterior Cliff detection

USPs Low power consumption Higher resolution than HALIOS®

Collision Warning

SPADs & SiPM

Autonomous Emergency Brake (AEB) Pedestrian detection Cross Traffic Alert (CTA)

USPs Lower operation voltage Embedded and compact solution

HALIOS® = High Ambient Light independent Optical System /ToF= Time of Flight/ SPAD=Single Photon Avalanche Diode/ LIDAR= Light Detection and Ranging

Agenda

- Solid State LiDAR System Considerations
 - Solid state scanning system comparison
 - Tradeoffs
- 256 x 16 SPAD Array and Readout IC
 - Architecture
 - Features
 - o Multievent
 - Coincidence
- Solid State LiDAR Demonstrator
 - 16 Channel Laser Driver
 - Optical Components
 - System Assembly

Agenda

- Solid State LiDAR System Considerations
 - Solid state scanning system comparison
 - Tradeoffs
- 256 x 16 SPAD Array and Readout IC
 - Architecture
 - Features
 - o Multievent
 - Coincidence
- Solid State LiDAR Demonstrator
 - 16 Channel Laser Driver
 - Optical Components
 - System Assembly



- Flash LiDAR
- No spacial modulation of light source (illumination of entire scene)
- Requires simultaneous operation of all pixels
- Solid State Scanning LiDAR
 - Spacial modulation of light source
 - Challenge of scanning transmitter and receiver simultaneously
 - Beam steering
 - Phased array (photonic IC)
 - Solid state
 - Scanning of both axes
 - MEMS Mirror
 - "Moving part"
 - Rolling Shutter SPAD array + solid state laser scanner
 - Scanning of transmitter and receiver by two independent mechanisms
 - No moving parts
 - CMOS implementation
 - Standard optical components
 - Scanning of one axis (parallel operation on other axis)

Trade-Offs in LIDAR Systems



- LIDAR is an active system, so the performance is equally determined by the performances of transmitter and receiver
- Eye safety regulations limit the maximum average power density that can be provided
- Trade-Offs of range, resolution, frame rate, and object reflectivity

Signal ∝ Transmitter Power Density •Transmitter Aperture²• Object Reflectivity • Receiver Aperture² Pulse Width •Resolution • Frame Rate • Distance²

> driven by application / market driven by application / market limited by eye safety regulation

Major parameters to impact on performance:

- Sender aperture
- Optical pulse width
- Receiver aperture

Agenda

- Solid State LiDAR System Considerations
 - Solid state scanning system comparison
 - Tradeoffs
- 256 x 16 SPAD Array and Readout IC
 - Architecture
 - Features
 - o Multievent
 - Coincidence
- Solid State LiDAR Demonstrator
 - 16 Channel Laser Driver
 - Optical Components
 - System Assembly

Elmos 256 x 16 Rolling Shutter CMOS SPAD Array

- 256 x 16 SPAD Array
- Elmos L035
- IMS SPAD architecture
- "Rolling shutter" architecture for improvement of fill-factor
- Photon counting mode for ambient light detection and 2D imaging
- Ready for auto-adjustment of photon coincidence
- Multi-event detection mode (up to 4 events per pixel and laser pulse)
- Column integrated TDC with 312.5 ps resolution (~5 cm resolution)
- 1.28 µs full range (192 m max. theoretical range)





Elmos 256 x 16 Rolling Shutter CMOS SPAD Array

Pixel

Active

Pulse

elmos Total Chip Size: 9200 x 9700 μm² 120µm SPADs 160µm Electronic 280µm Line Pitch SPAD area 30µm SPAD 4 SPADs per 256 columns x 16 rows (7800 x 4550 μm²) Active: 21.6µm Coincidence Circuits Quenching Time-to-Digital **Converters Peripheral electronics** Shaping for high fill factor Output: 2 x 12 bit digital

Multi Event Detection: 2nd /3rd /4th Photon Detection emos

- For high background rate the Probability Density Function (PDF) of 1st / (i+1) photon in given by a modified Erlang distribution
- Multi Event Depth of 4 is good compromise between signal improvement and 1200 complexity increase Event 1 Event 2 1000 Event 3 Event 4 Simulation 800 Count 600 400 200 0 1000 2000 3000 0 4000

Bins

Temporal Photon Coincidence



Statistical model with 4 SPADs per pixel "x out of 4" $T_{\rm K}$ ₹7 \bigcirc Parameters Coincidence depth • • • ••• Coincidence time 10 MHz Improvement of signal-to-background ratio (SBR) Coincidence Detection Rate A 1 MHz "Background" can be Best working – Light range Noise (Rain / Snow) Temperature (DCR) 100 kHz 3 / 16ns 4 / 16ns 3 / 8ns 2 / 8ns Keep sensor in ideal signal range 3/ 4ns High count rate: dead time becomes dominant 3 / 1.5ns 2 / 1.5ns 10 kHz 1 MHz 10 MHz 100 MHz Low count rate: poor histogramming Photon Detection Rate Nλ $1 \text{ MHz} \cong 1 \text{ klux}$

Temporal Photon Coincidence

elmos

Without Coincidence





Multi Object Detection



- Improved detection of small objects
- Improved detection of transparent objects



Agenda

- Solid State LiDAR System Considerations
 - Solid state scanning system comparison
 - Tradeoffs
- 256 x 16 SPAD Array and Readout IC
 - Architecture
 - Features
 - o Multievent
 - Coincidence
- Solid State LiDAR Demonstrator
 - 16 Channel Laser Driver
 - Optical Components
 - System Assembly

- No moving parts on either the macro or the micro scale
- Highly efficient and scalable
- Energy is only emitted into the observed field of view (1 x 16 laser array)
- Observed field of view is only extending over illuminated area (rolling shutter)



- No moving parts on either the macro or the micro scale
- Highly efficient and scalable
- Energy is only emitted into the observed field of view (1 x 16 laser array)
- Observed field of view is only extending over illuminated area (rolling shutter)



- No moving parts on either the macro or the micro scale
- Highly efficient and scalable
- Energy is only emitted into the observed field of view (1 x 16 laser array)
- Observed field of view is only extending over illuminated area (rolling shutter)



- No moving parts on either the macro or the micro scale
- Highly efficient and scalable
- Energy is only emitted into the observed field of view (1 x 16 laser array)
- Observed field of view is only extending over illuminated area (rolling shutter)



T914.25 – Features

- 16 channel laser driver
- 4 x 4 common cathode switching
- 1 ns pulse width @ 50 A peak current
- Configurable pulse width and delay 1-15 ns
- 10 ps resolution
- HV charge and discharge function per channel
- Digital readout of laser pulse energy by detection of residue charge on capacitors (switched capacitor)
- Control of average laser power
- Monitoring of eye safety
- 10 temperature sensors with digital readout
- 100MHz SPI interface
- On-chip channel sequencer matching SPAD array T955510
- D035 with thick metal option T
- Metal 5 RDL layer for die stacking
- Die size 10 x 4 mm²







- 4 x 4 Channel common cathode switching
- Full integration of pre-driver, output FET, HV switches and digital control



Pulsed Laser Driver Architecture



- Ultra-short high current pulse generation
- Self-similar driver structure
- 4 distributed inverter stages in series
- Fanout 4 per stage
- Balanced propagation delay on all sub-structures
- Signal shaping in every stage
- Signal routing requires only one metal layer





NFET UNIT

Interleaved Structure of Gate Driver and NFET



8652.15 um

- 16 channel module
- Single-channel edge emitting lasers gradually rotated up to ±10° for massive simplification of optics
- Compact single lens design for vertical focusing and horizontal de-focusing
- 32 x 1nF 50V silicon capacitors

3836.02 um

Laser Diode – Inhomogenious Current Distribution

Lumped Element Current



Time / ns

CST Simulation – Influence of Bondwires on Inductance **elmos**



- 4nF capacitance per channel
- 300pH total inductance per channel
- 1 ns FWHM pulse width @ 50 A peak current (starrc back annotation)
- "Active Off" Switching: Self inductance generates negative voltage on laser for fast falling edge



- Time resolution limited by 600 MHz oscilloscope
- Coarse pulse width setting 1, 3, 4, 5, 6



Transmitter Lens – 3D Model – 16.5 x 5.5 x 1.5 mm³ **elmos**^{*}



Laser Scanner – Vertical Focusing by Cylinder Lens



Laser Scanner – Horizontal Flat-Fielding by Powell Lens **elmos**



Illumination Pattern @ 20m Distance



Detector Image: Incoherent Irradiance	
27.05.2019 Detector 8, NSCG Surface 1: Detector@20m Size 16000,000 W X 12000,000 H Millimeters, Pixels 6000 W X 6000 H, Total Hits = 15887279 Peak Irradiance : 2,4422E-04 Watts/cm^2 Total Power : 7,3522E+00 Watts	Zemax Zemax OpticStudio 18.9
	ALIS16_Scanlens_Laser_SourceDiode.zmx Configuration 1 of 1

Horizontal Intensity Distribution of Laser Line



Incoherent Irradiance	
28.05.2019 Detector 8, NSCG Surface 1: Detector@20mRow Center, Y = 0,0000E+00 Size 16000,000 W X 12000,000 H Millimeters, Pixels 1600 W X 1200 H, Total Hits = 7967379 Peak Irradiance : 9,6783E-05 Watts/cm^2 Total Power : 7,3731E+00 Watts	Zemax Zemax OpticStudio 18.9
	ALIS16_Scanlens_Laser_SourceDiode.zmx Configuration 1 of 1

Scan Lens V1





Optical Test Setup





Scale Images of Transmitter and Receiver Array





Scan Lens V1 – Test Results

- Proof of prciple
- Good vertical focusing
- Constant line spacing
- Slight fabrication errors
- **Cushion distortion**
- Defocus at end of lines









Scanlens V1 – Simulation





Scan Lens V2 – Focal Correction





Scan Lens V3 – Brightness Correction



Scan Lens V4 – Distortion Correction









16-Channel Pulsed Laser Driver Module – Multi Chip Stack



16-Channel Pulsed Laser Driver Module – Camera Package



256 x 16 SPAD Array Sensor Board – USB 3.0 SuperSpeed Connectivity









Solid State Scanning LIDAR Camera – Features I

Solid State Scanning LIDAR Camera

- 16 channel pulsed laser module
- Rolling shutter 256 x 16 pixel CMOS SPAD array
- USB 3.0 SuperSpeed connectivity
- Ultra short laser pulse width 1ns
- Up to 3Gb/s raw data rate
- No moving parts
- Bus powered



1st Generation Multi-Channel Laser Driver Module

- 16-channel configurable laser driver IC
- 16x Excelitas edge emitting 905nm pulsed laser diodes
- 32x Murata 1nF UWSC caps
- Ins pulse width @ 50A peak current
- HV charge & discharge function/channel
- Lowest inductance stack-up multi-channel driver
- Scalable building block approach for high channel count
- Build on robust & automotive qualified process

Special Features

- Configurable pulse width & delay 1-15ns
- 10ps resolution
- Integrated diagnostics & measurement
- Control average laser power
- Monitoring of eye safety
- 10x temp sensors w/digital readout
- 100MHz SPI interface
- On-chip channel sequencer

elmos

CELITAS

2nd Generation SPAD Array

- 256 x 16 CMOS SPAD Array
- Massive parallel data processing with multi-channel TDC
- 3mm distance resolution by interpolation
- 192m full range
- Rolling shutter operation
- Build on robust & automotive qualified process
- Active quenching circuit for SPAD dead-time variation
- 4x vertically arranged single SPADs
- Multi-event detection mode
 - Up to 4x event/px & pulse
 - Increased Range & Noise Immunity
- Auto-coincidence circuit for high ambient light rejection
- Statistical evaluation offers rich analysis of raw data
 - Distance
 - Brightness / ambient light
 - Visualization of multiple reflections
 - Rain and fog detection



Solid State Scanning LIDAR Camera – 3D Image Data



Acknowledgments

elmos



Contact: Dr. André Srowig System Development Engineer Email: andre.srowig@elmos.com

Thank you for your attention!

Elmos Semiconductor AG

elmos

Heinrich-Hertz-Str. 1 | 44227 Dortmund | Germany Telephone: + 49 231 75 49 0 | Telefax: + 49 231 75 49 149 info@elmos.com | www.elmos.com

DISCLAIMER

This presentation contains forward-looking statements based on beliefs of Elmos' management. Such statements reflect the company's current views with respect to future events and are subject to risks and uncertainties. Many factors could cause the actual results to be materially different, including, among others, changes in general economic and business conditions, changes in currency exchange rates and interest rates, introduction of competing products, lack of acceptance of new products or services and changes in business strategy. Actual results may vary materially from those projected here. Elmos does not intend or assume any obligation to update these forward-looking statements.

True Solid State Scanning LIDAR System

- System features
 - 3mm distance resolution
 - 40 fps framerate
 - 192m range
- 16 channel pulsed laser module
 - 1ns pulse width @ 50A peak current
 - Integrated diagnostics & measurement
 - Control of average laser power
 - Monitoring of eye safety
- 256 x 16 pixel CMOS SPAD array
 - Rolling shutter
 - Auto-coincidence circuit
 - Multi-event detection





